

# Detailed Simulation of Track Ionization in CCDs

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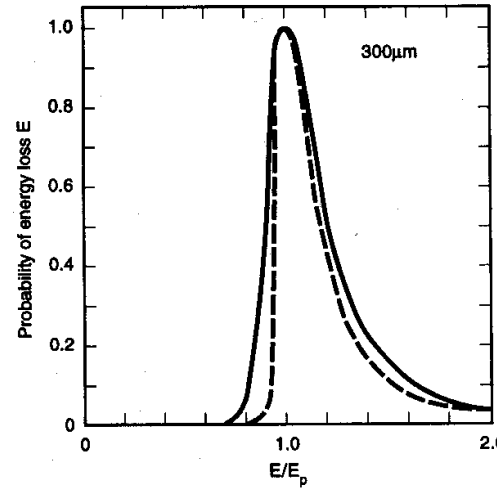
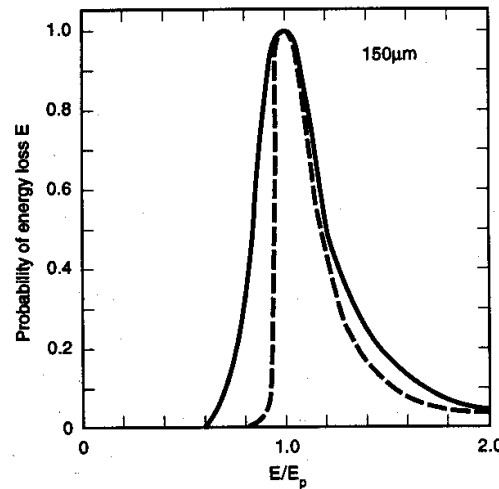
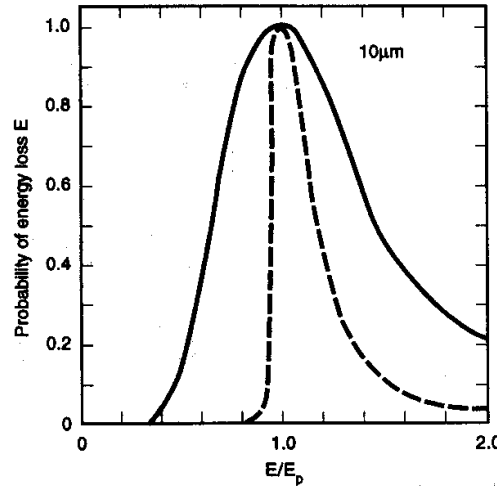
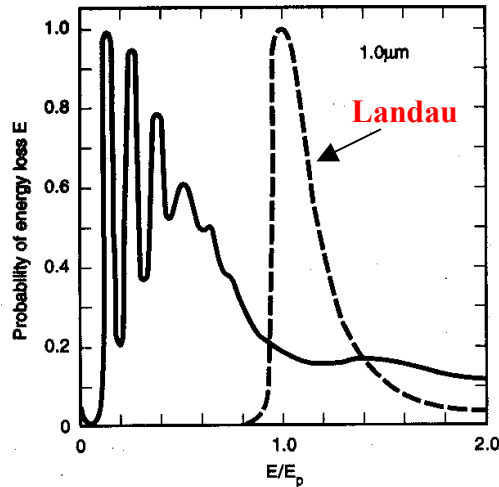
Santa Cruz LC Retreat, Jun/27-29/02  
Vertex detector parallel session

# Functionality of the CCD Simulation

- A standalone tool for CCD vertex detector design optimization:
  - Track ionization a la Hans Bichsel  $dE/dx$  scheme
  - Charge diffusion and collection simulation
  - Readout noise and charge transfer efficiency
  - Frontend cluster processing and offline cluster recon
- Some tasks it might serve:
  - Readout electronics noise effect on resolution
  - Pixel size and active silicon depth optimization for efficiency and resolution
  - Clustering centroid algorithm development

*Much of the work was done 10 years ago for SLD VXD design and need to migrate to LC simulation framework*

# Track ionization is surely well understood ?



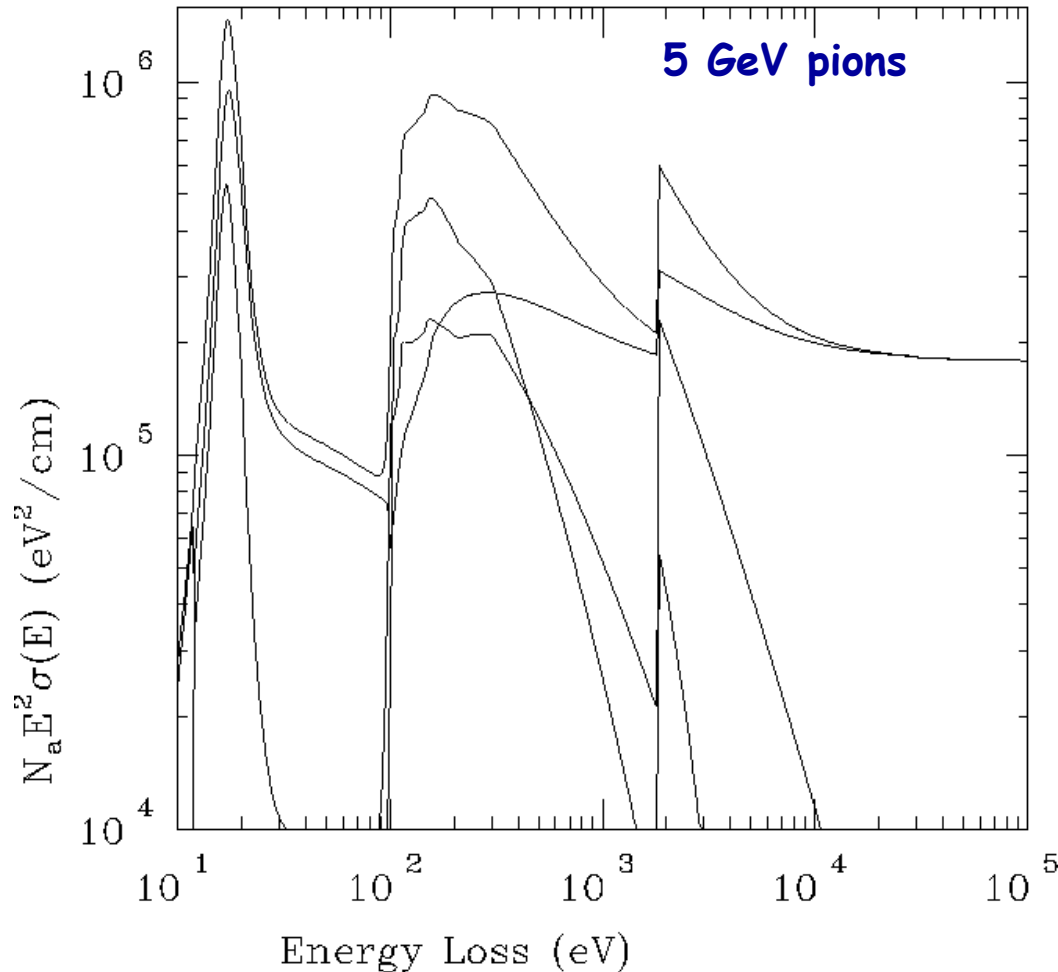
May be understood by a few, but not picked up by most simulation. Various kluges (e.g. Landau convoluted with Gaussian) help at limited thickness range and breakdown for very thin layers.

Not just a problem for silicon. Drift-chamber  $dE/dx$  for a single wire layer typically suffer similarly.

*Can we do better than just "Smear it" ?*

# Hans Bichsel 'Fold' Technique

Collision Cross Section Spectrum



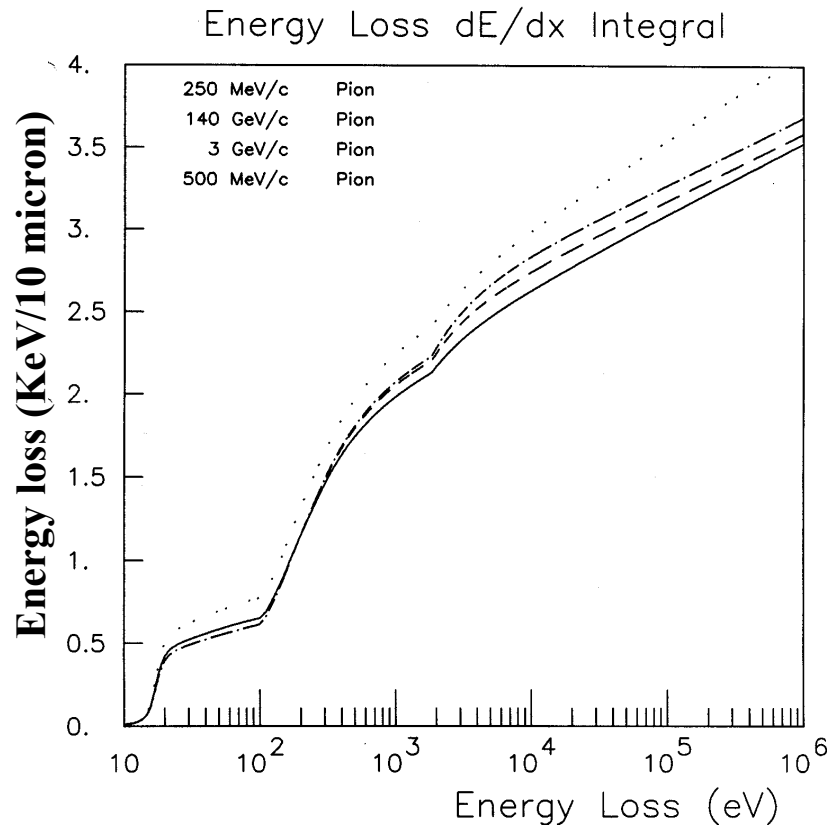
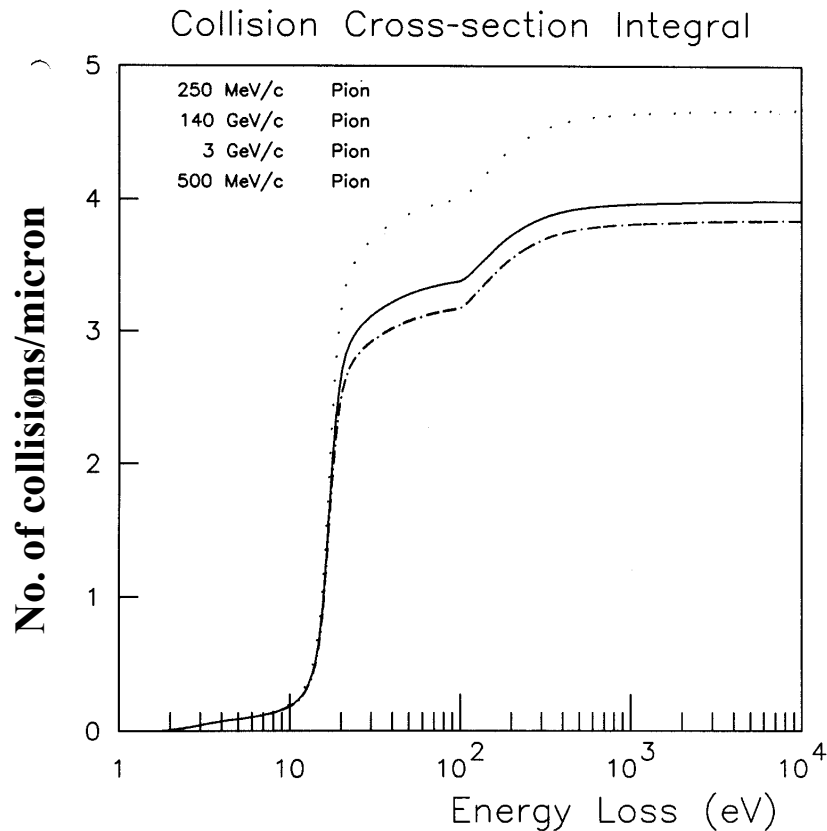
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H. Bichsel, *Rev. Mod. Phys.* Vol 60, 663 (1988)

Detailed single atomic collision spectrum from a combination of atomic theory and data.

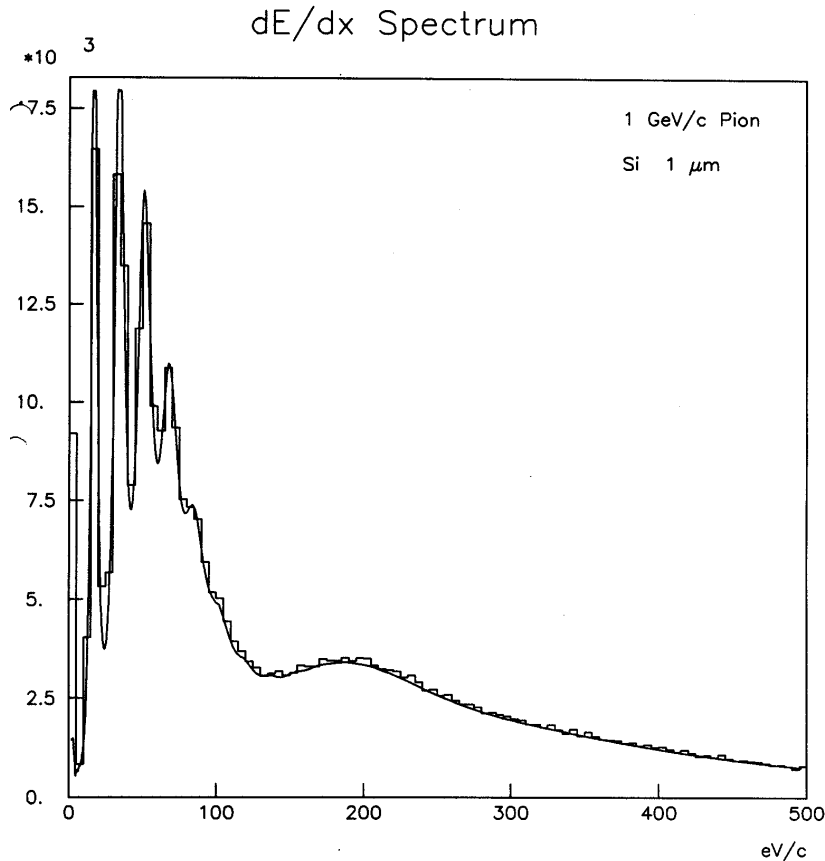
Start with a very thin layer with  $\ll 1$  collision on average. Convolute (fold) same distribution to double thickness. Repeat until reach desired thickness.

# $dE/dx$ atomic collision integral contributions



**Interesting facts:  $\sim 4$  collisions/micron and  $< 1$  collision/micron with  $E_{\text{loss}} > 100\text{eV}$ , but  $\sim$  half the energy loss from  $> 1$  KeV collisions in 20 micron silicon.**

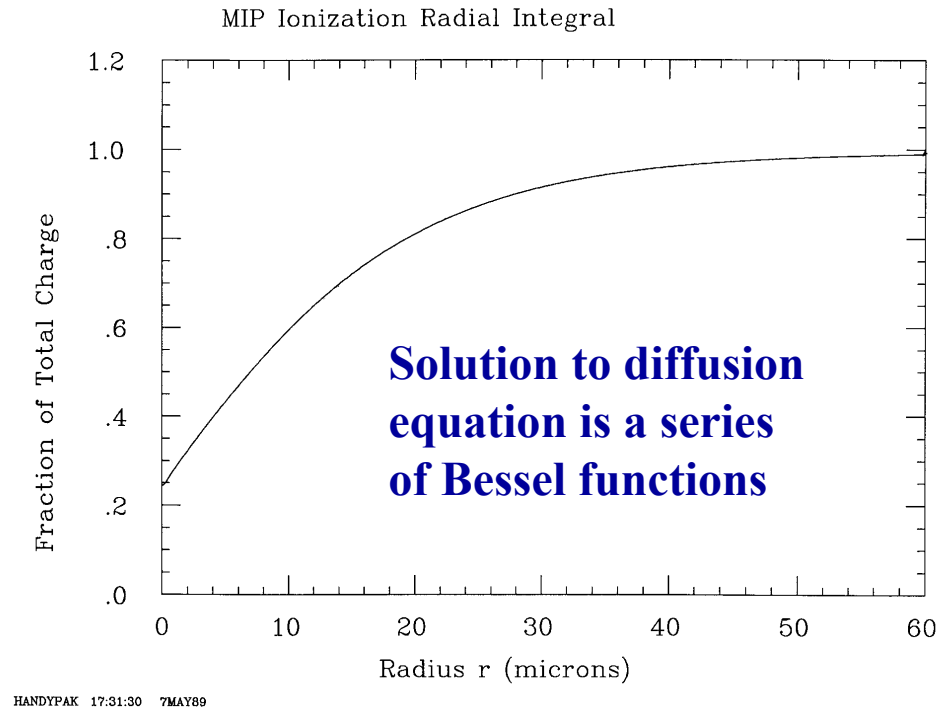
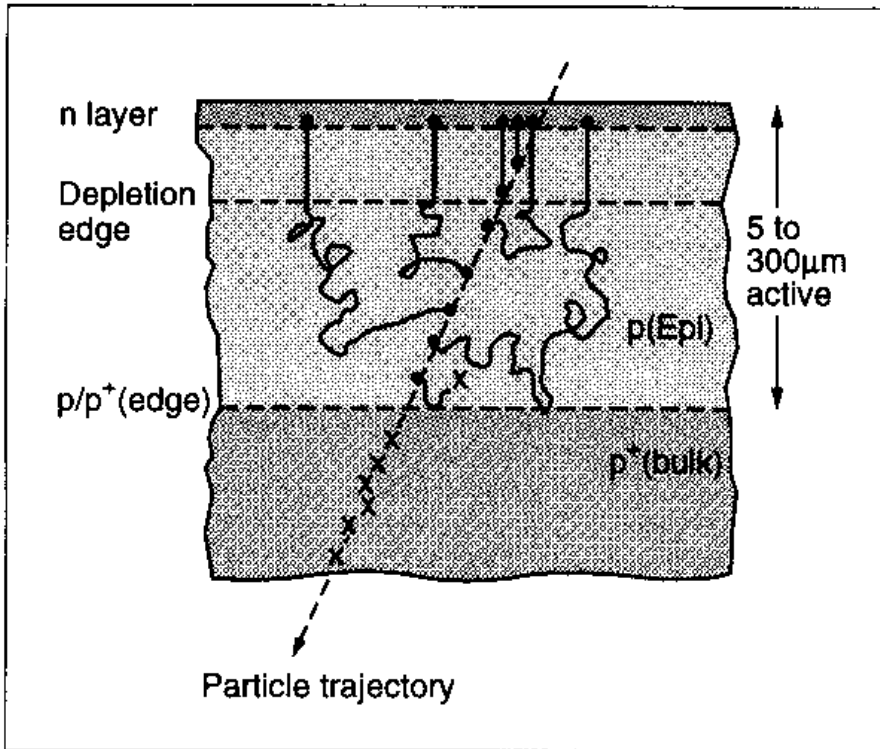
# Simulation procedure



- Divide active silicon into 1 μm depth slices. For given charged particle momentum (b) and entrance angle make initial calculation of dE/dx spectrum within slice (integral form)
- Each track loops over slices to generate  $E_{\text{loss}}$  per slice.
- Convert  $E_{\text{loss}}$  into ionization electrons and diffuse them (one or few at a time) to see which pixel they get collected.

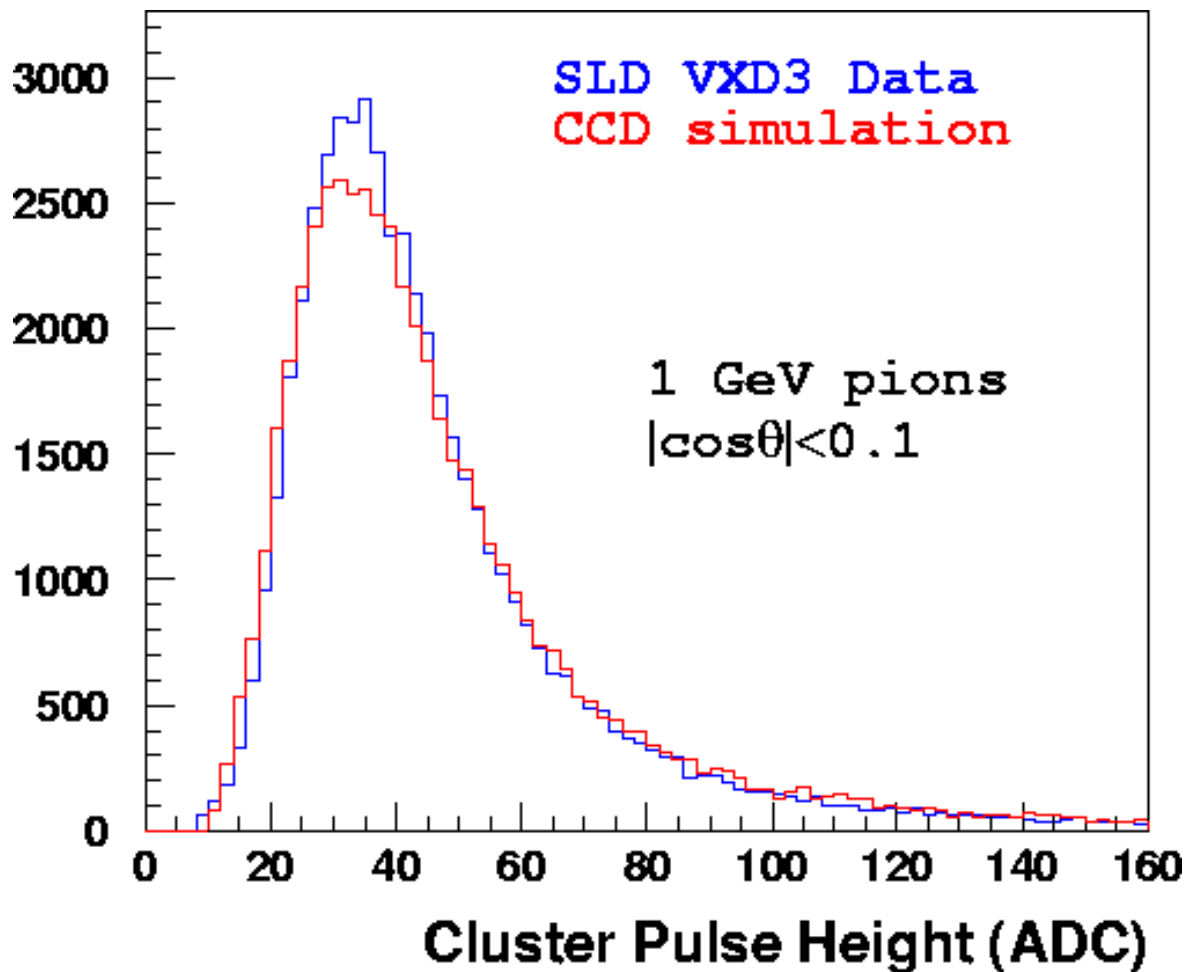
After charge collection done for all hits, generate readout noise  
And do clustering simulation and cluster reconstruction.

# Charge Diffusion



e.g. SLD VXD3 CCD has total 20 $\mu$ m EPI silicon. Only top 3-4 $\mu$ m is depleted. The diffusion in undepleted region and reflective P+ substrate are very helpful to spread out charge for better cluster centroid reconstruction.

# Performance compared to data ?



More detailed tests  
on cluster shapes to  
follow...

Spatial resolution  
prediction:  $3.9\mu\text{m}$   
SLD achieved data  
resolution:  $3.8\mu\text{m}$

(caveat: this  
simulation is using an  
older crude cluster  
centroid algorithm !  
Data had max pixel  
charge corr. And pixel  
position dep. Corr.)



# What can be looked at with this simulation ?

- Pixel size, EPI / depletion depth optimization.
- Track entrance angle effects.
- Frontend clustering noise suppression technique.
- Cluster centroid algorithm tests.
- Readout noise effects:

A quick test for SLD VXD3 CCDs:

raw mode noise (e)	resolution ( $\mu\text{m}$ )
32	3.9
64	4.5
16	3.2

- Probably many other tests too...

# Simulation code status

- Still only have VMS fortran version. Conversion to run on UNIX is in progress. Bichsel code very difficult to convert to C++. Other code can be migrated to C++. (Valerie Halyo interested in helping on this).
- Some work is needed to skim some SLD data for validating the simulation.
- Will make documentation and make the package publicly available.
- Plugging into GEANT ?
  - Initial dE/dx spectrum need to be parameterized for various particle boost  $\beta$ .
  - Need to examine code efficiency for speed and cut down unnecessary fine divisions.